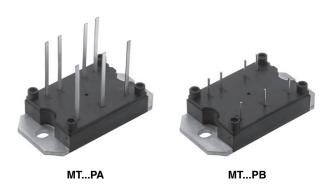


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COMPLIANT

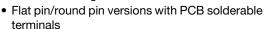
Three Phase Bridge (Power Modules), 45 A to 100 A



PRODUCT SUMMARY				
Io	45 A to 100 A			
V _{RRM}	1600 V			
Package	MTPA, MTPB			
Circuit	Three phase bridge			

FEATURES

- Low V_F
- Low profile package
- · Direct mounting to heatsink



- Low junction to case thermal resistance
- 3500 V_{RMS} insulation voltage
- UL approved file E78996 **Tu** vie
- Designed and qualified for industrial level
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Power conversion machines
- Welding
- UPS
- SMPS
- Motor drives
- General purpose and heavy duty application

DESCRIPTION

A range of extremely compact three-phase rectifier bridges offering efficient and reliable operation. The low profile package has been specifically conceived to maximize space saving and optimize the electrical layout of the application specific power supplies.

MAJOR RATINGS AND CHARACTERISTICS					
SYMBOL	CHARACTERISTICS	VALUES 40MT	VALUES 70MT	VALUES 100MT	UNITS
1		45	75	100	Α
IO	T _C	100	80	80	°C
	50 Hz	270	380	450	^
I _{FSM}	60 Hz	280	398	470	A A
I ² t	50 Hz	365	724	1013	A ² s
1-1	60 Hz	325	660	920	A ² S
I ² √t		3650	7240	10 130	A ² √s
V _{RRM}		1600			V
T _{Stg}	Panga	-40 to 125			°C
T _J	Range		-40 to 150		

ELECTRICAL SPECIFICATIONS

VOLTAGE RATINGS				
TYPE NUMBER	VOLTAGE CODE REVERSE VOLTAGE V	V _{RRM} , MAXIMUM REPETITIVE PEAK REVERSE VOLTAGE V	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK V	I _{RRM} MAXIMUM AT T _J = 150 °C mA
VS-40MT160P, VS-70MT160P, VS-100MT160P	160	1600	1700	5



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FORWARD CONDUCTION								
PARAMETER	SYMBOL		TEST CONDITIONS			VALUES 70MT	VALUES 100MT	UNITS
Maximum DC output		1000			45	75	100	А
current at case temperature	I _O	120° rect. to	conduction angle		100	80	80	°C
		t = 10 ms	No voltage		270	380	450	
Maximum peak, one cycle	_	t = 8.3 ms	reapplied		280	398	470	1 ,
forward, non-repetitive on state surge current	I _{FSM}	t = 10 ms	100 /0 VRRM		225	320	380	A
		t = 8.3 ms		Initial	240	335	400	
	t	t = 10 ms	No voltage reapplied	$T_J = T_J$ maximum	365	724	1013	
Maximum I ² t for fusing	l ² t	t = 8.3 ms			325	660	920	A ² s
Waxiinuin i-t for fusing	1-1	t = 10 ms	100 % V _{RRM}		253	512	600	A-5
		t = 8.3 ms	reapplied		240	467	665	
Maximum I ² √t for fusing	I ² √t	t = 0.1 ms to	t = 0.1 ms to 10 ms, no voltage reapplied			7240	10 130	A²√s
Value of threshold voltage	V _{F(TO)}	T. maximum			0.78	0.82	0.75	V
Slope resistance	r _t	ıjınaxımum	T _J maximum			9.5	8.1	mΩ
Maximum forward voltage drop	V _{FM}		$T_J = 25$ °C; $t_p = 400 \mu s$ single junction (40MT, $l_{pk} = 40 A$) (70MT, $l_{pk} = 70 A$) (100MT, $l_{pk} = 100 A$)			1.45	1.51	V

INSULATION TABL	E					
PARAMETER	SYMBOL	TEST CONDITIONS	40MT	70MT	100MT	UNITS
RMS insulation voltage	V _{INS}	T _J = 25 °C, all terminal shorted, f = 50 Hz, t = 1 s		3500		V

THERMAL AND MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	40MT	70MT	100MT	UNITS
Maximum junction operating temperature range	TJ			- 40 to 15	0	°C
Maximum storage temperature range	T _{Stg}			- 40 to 12	5	C
	R _{thJC}	DC operation per module	0.27	0.23	0.19	
Maximum thermal resistance,		DC operation per junction	1.6	1.38	1.14	
junction to case		□thJC	120° rect. condunction angle per module	0.38	0.29	0.22
		120° rect. condunction angle per junction	2.25	1.76	1.29	K/W
Maximum thermal resistance,case to heatsink per module	R _{thCS}	Mounting surface smooth, flat and greased Heatsink compound thermal conductivity = 0.42 W/mK	0.1			
Mounting torque to heatsink ± 10 %		A mounting compound is recommended and the torque should be rechecked after a period of 3 hours to allow for the spread of the compound. Lubricated threads 4 65		4		Nm
Approximate weight					g	

CLEARANCE AND CREEPAGE DISTANCES					
PARAMETER	TEST CONDITIONS	MTPA	MTPB	UNITS	
Clearance	External shortest distances in air between terminals which are not internally short circuited together	10.9 12.3		mm	
Creepage distance	Shortest distance along external surface of the insulating material between terminals which are not internally short circuited together	10.9 12.3		mm	

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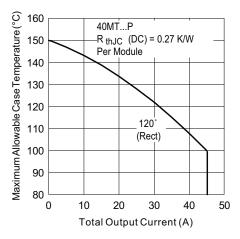


Fig. 1 - Current Rating Characteristics

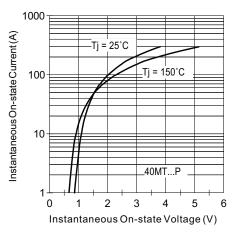


Fig. 2 - On-State Voltage Drop Chracteristics

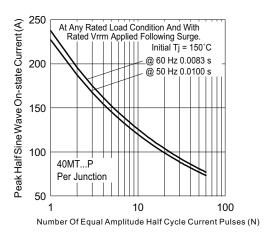


Fig. 3 - Maximum Non-Repetitive Surge Current

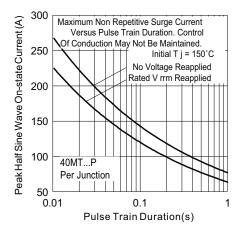


Fig. 4 - Maximum Non-Repetitive Surge Current

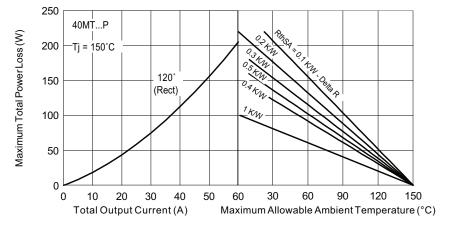


Fig. 5 - Current Rating Nomogram (1 Module Per Heatsink)

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Fig. 6 - Current Rating Characteristics

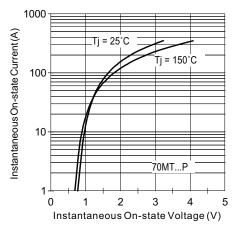


Fig. 7 - On-State Voltage Drop Characteristics

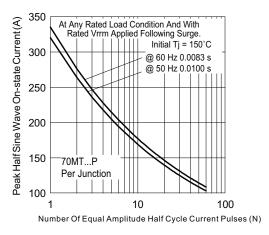


Fig. 8 - Maximum Non-Repetitive Surge Current

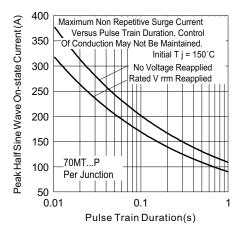


Fig. 9 - Maximum Non-Repetitive Surge Current

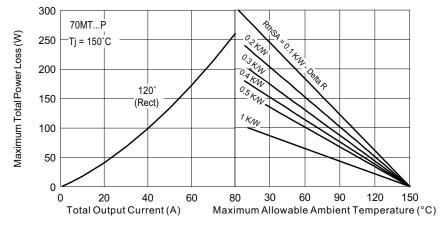


Fig. 10 - Current Rating Nomogram (1 Module Per Heatsink)

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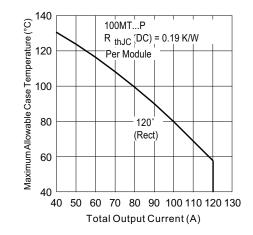


Fig. 11 - Current Rating Characteristics

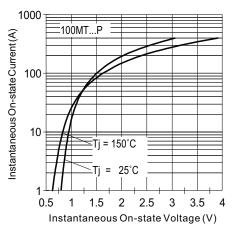


Fig. 12 - On-State Voltage Drop Characteristics

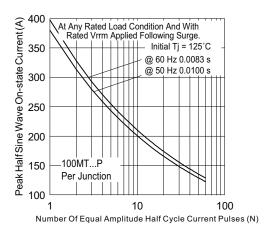


Fig. 13 - Maximum Non-Repetitive Surge Current

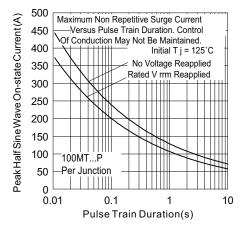


Fig. 14 - Maximum Non-Repetitive Surge Current

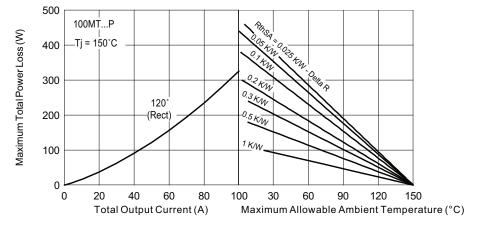


Fig. 15 - Current Rating Nomogram (1 Module Per Heatsink)

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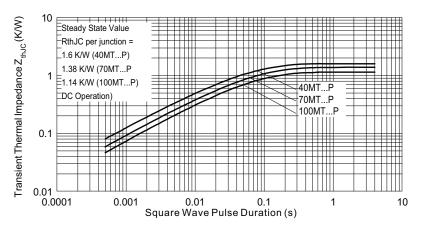
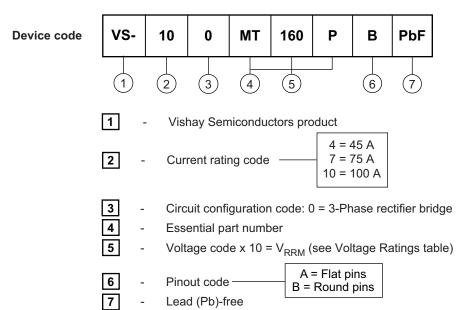
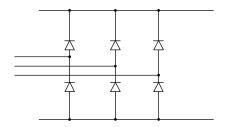


Fig. 16 - Thermal Impedance Z_{thJC} Characteristics

ORDERING INFORMATION TABLE



CIRCUIT CONFIGURATION



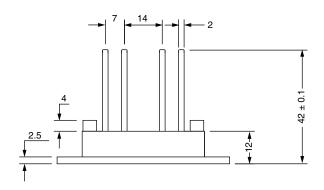
LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95244			

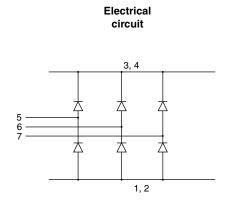


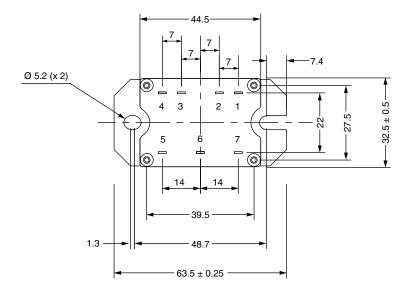
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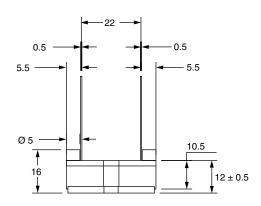
MTP Flat and Round Pin

DIMENSIONS FOR MTP WITH FLAT PIN in millimeters







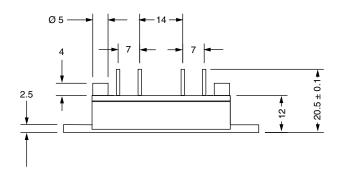


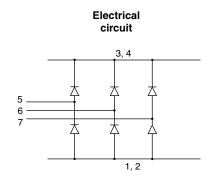
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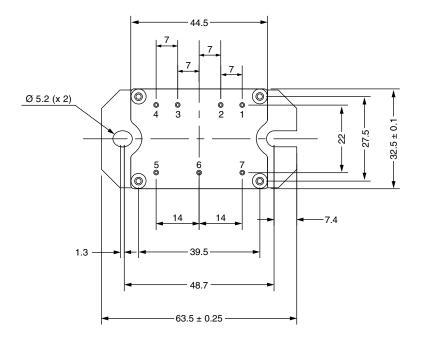
MTP Flat and Round Pin

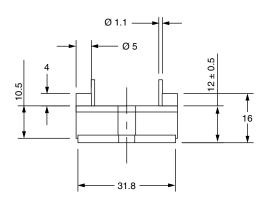


DIMENSIONS FOR MTP WITH ROUND PIN in millimeters









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